

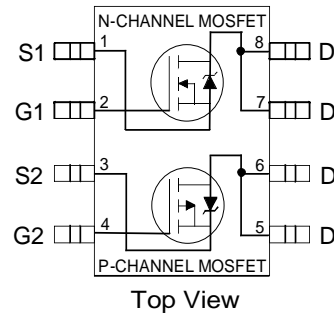
Features

N-Ch:

- $V_{DS} (V) = 30V$
- $R_{DS(ON)} < 50m\Omega$ ($V_{GS} = 4.5V$)
- $R_{DS(ON)} < 70m\Omega$ ($V_{GS} = 2.7V$)

P-Ch:

- $V_{DS} (V) = -30V$
- $R_{DS(ON)} < 100m\Omega$ ($V_{GS} = 4.5V$)
- $R_{DS(ON)} < 140m\Omega$ ($V_{GS} = 2.7V$)
- Industry-standard pinout SO-8 Package
- Compatible with Existing Surface Mount Techniques



Benefits

- Multi-Vendor Compatibility
- Easier Manufacturing
- Environmentally Friendlier
- Increased Reliability

Absolute Maximum Ratings

Parameter		Max.		Units
		N-Channel	P-Channel	
$I_D @ T_A = 25^\circ C$	10 Sec. Pulse Drain Current, $V_{GS} @ 10V$	4.7	-3.5	A
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	4.0	-3.0	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	3.2	-2.4	A
I_{DM}	Pulsed Drain Current Φ	16	-12	A
$P_D @ T_A = 25^\circ C$	Power Dissipation (PCB Mount)**	1.4		W
	Linear Derating Factor (PCB Mount)**	0.011		W/°C
V_{GS}	Gate-to-Source Voltage	± 20		V
dv/dt	Peak Diode Recovery dv/dt Φ	6.9	-6.0	V/ns
T_J, T_{STG}	Junction and Storage Temperature Range	-55 to + 150		°C

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JA}$	Junction-to-Amb. (PCB Mount, steady state)**			90	°C/W

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Parameter	Description	N-Ch	P-Ch	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	30	-30				V	$V_{GS} = 0V, I_D = 250\mu A$ $V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient			0.032			V/°C	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$ Reference to $25^\circ\text{C}, I_D = -1\text{mA}$
$R_{DS(ON)}$	Static Drain-to-Source On-Resistance	N-Ch	P-Ch			50	m Ω	$V_{GS} = 10V, I_D = 2.4A$ ③
						70		$V_{GS} = 4.5V, I_D = 2.0A$ ③
				100	$V_{GS} = -10V, I_D = -1.8A$ ③			
				140	$V_{GS} = -4.5V, I_D = -1.5A$ ③			
$V_{GS(th)}$	Gate Threshold Voltage	1.0	-1.0				V	$V_{DS} = V_{GS}, I_D = 250\mu A$ $V_{DS} = V_{GS}, I_D = -250\mu A$
g_{fs}	Forward Transconductance	N-Ch	P-Ch	5.2			S	$V_{DS} = 15V, I_D = 2.4A$ ③
				2.5			$V_{DS} = -24V, I_D = -1.8A$ ③	
I_{DSS}	Drain-to-Source Leakage Current	N-Ch	P-Ch			1.0	μA	$V_{DS} = 24V, V_{GS} = 0V$
						-1.0		$V_{DS} = -24V, V_{GS} = 0V$
						25		$V_{DS} = 24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
						-25		$V_{DS} = -24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage					± 100	μA	$V_{GS} = \pm 20V$
Q_g	Total Gate Charge					25	nC	N-Channel $I_D = 2.6A, V_{DS} = 16V, V_{GS} = 4.5V$ ③
Q_{gs}	Gate-to-Source Charge				2.9			
Q_{gd}	Gate-to-Drain ("Miller") Charge	N-Ch	P-Ch			7.9	nC	P-Channel $I_D = -2.2A, V_{DS} = -16V, V_{GS} = -4.5V$
						9.0		
$t_{d(on)}$	Turn-On Delay Time			6.8			ns	N-Channel $V_{DD} = 10V, I_D = 2.6A, R_G = 6.0\Omega, R_D = 3.8\Omega$ ③
t_r	Rise Time			21				
$t_{d(off)}$	Turn-Off Delay Time			22				
t_f	Fall Time			7.7				
L_D	Internal Drain Inductance			4.0			nH	Between lead tip and center of die contact
L_S	Internal Source Inductance			6.0				
C_{iss}	Input Capacitance	N-Ch	P-Ch			520	μF	N-Channel $V_{GS} = 0V, V_{DS} = 15V, f = 1.0\text{MHz}$ ③
						440		
C_{oss}	Output Capacitance	N-Ch	P-Ch			180	μF	P-Channel $V_{GS} = 0V, V_{DS} = -15V, f = 1.0\text{MHz}$ ③
						200		
C_{rss}	Reverse Transfer Capacitance	N-Ch	P-Ch			72	μF	
						93		

Source-Drain Ratings and Characteristics

Parameter	Description	N-Ch	P-Ch	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)					1.8	A	
						-1.8		
I_{SM}	Pulsed Source Current (Body Diode) ①	N-Ch	P-Ch			16		
						-12		
V_{SD}	Diode Forward Voltage	N-Ch	P-Ch			1.0	V	$T_J = 25^\circ\text{C}, I_S = 1.8A, V_{GS} = 0V$ ③
						-1.0		$T_J = 25^\circ\text{C}, I_S = -1.8A, V_{GS} = 0V$ ③
t_{rr}	Reverse Recovery Time			47	71		ns	N-Channel $T_J = 25^\circ\text{C}, I_F = 2.6A, di/dt = 100A/\mu s$
Q_{rr}	Reverse Recovery Charge			56	84			P-Channel $T_J = 25^\circ\text{C}, I_F = -2.2A, di/dt = 100A/\mu s$ ③
t_{on}	Forward Turn-On Time			N-P Intrinsic turn-on time is negligible (turn-on is dominated by $t_S + L_D$)				

① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 23)

 ② N-Channel $I_{SD} \leq 2.4A, di/dt \leq 73A/\mu s, V_{DD} \leq V_{(BR)DSS}, T_J \leq 150^\circ\text{C}$
 P-Channel $I_{SD} \leq -1.8A, di/dt \leq 90A/\mu s, V_{DD} \leq V_{(BR)DSS}, T_J \leq 150^\circ\text{C}$

 ③ Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.

N-Channel

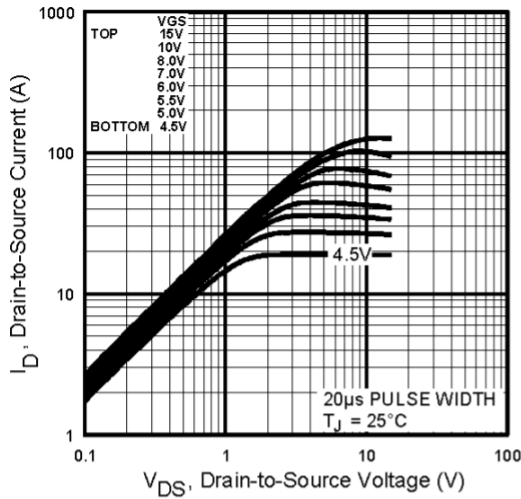


Fig 1. Typical Output Characteristics,
 $T_J = 25^\circ\text{C}$

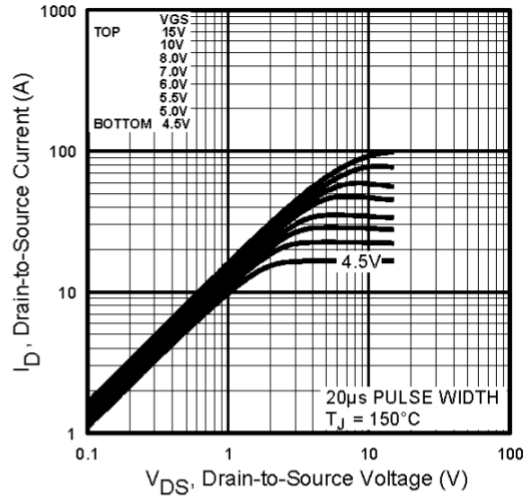


Fig 2. Typical Output Characteristics,
 $T_J = 150^\circ\text{C}$

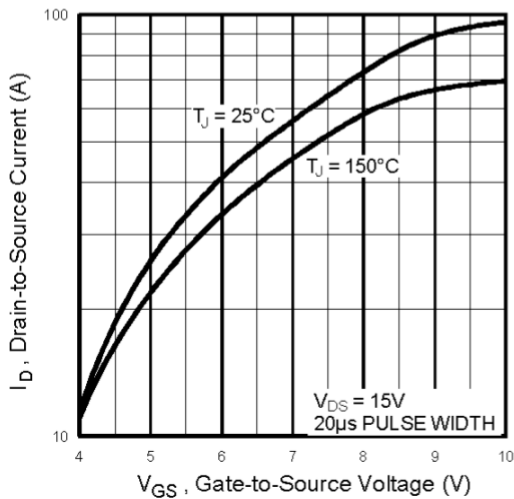


Fig 3. Typical Transfer Characteristics

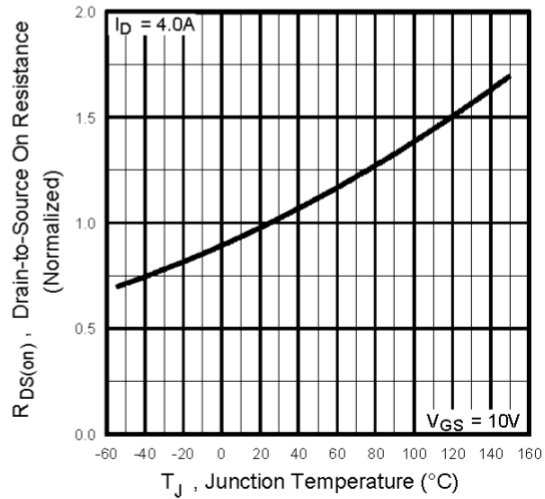


Fig 4. Normalized On-Resistance
Vs. Temperature

N-Channel

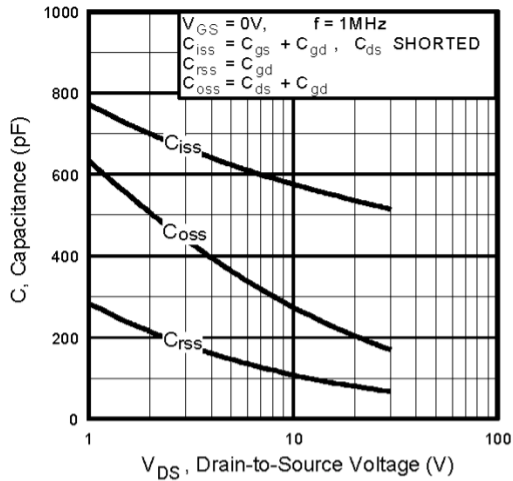


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

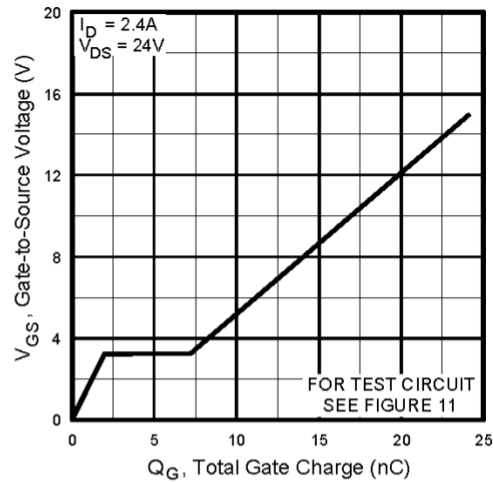


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

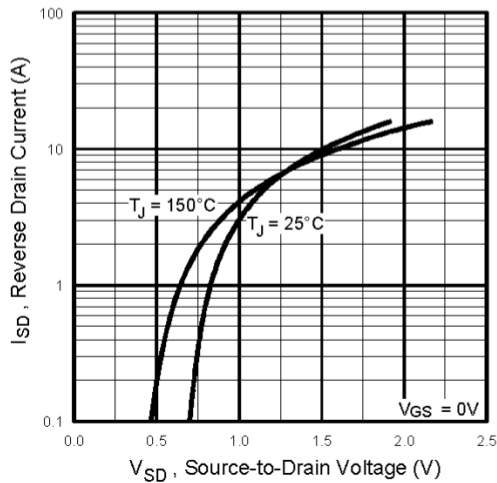


Fig 7. Typical Source-Drain Diode Forward Voltage

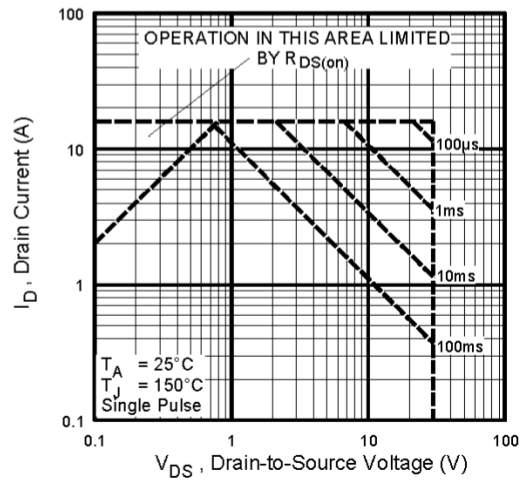


Fig 8. Maximum Safe Operating Area

N-Channel

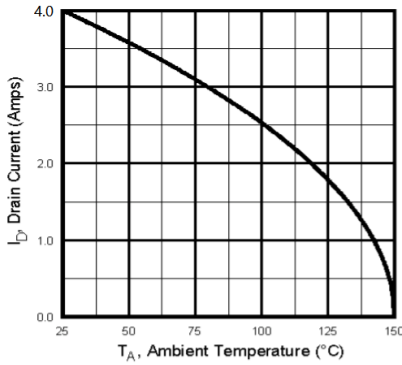


Fig 9. Max. Drain Current Vs. Ambient Temp.

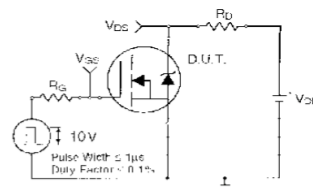


Fig 10a. Switching Time Test Circuit

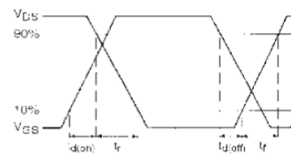


Fig 10b. Switching Time Waveforms

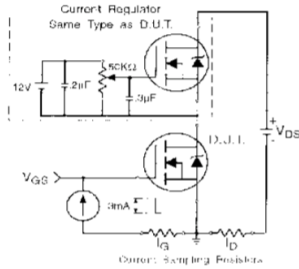


Fig 11a. Gate Charge Test Circuit

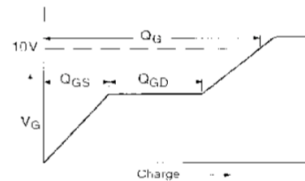


Fig 11b. Basic Gate Charge Waveform

P-Channel

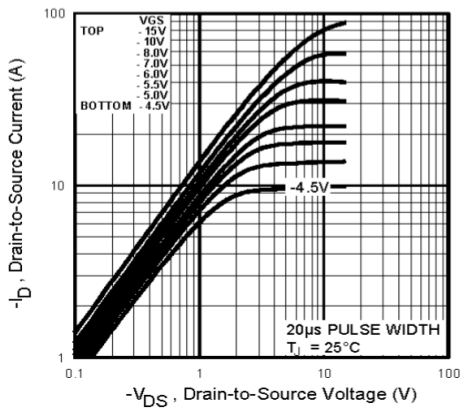


Fig 12. Typical Output Characteristics, $T_J = 25^\circ\text{C}$

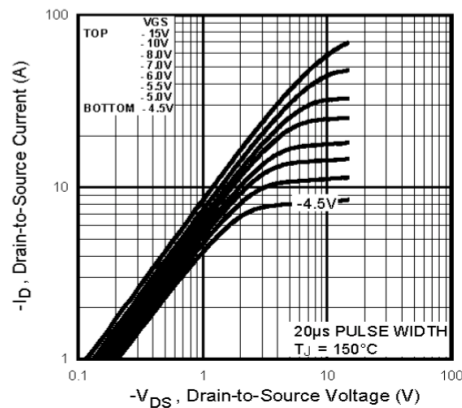


Fig 13. Typical Output Characteristics, $T_J = 150^\circ\text{C}$

P-Channel

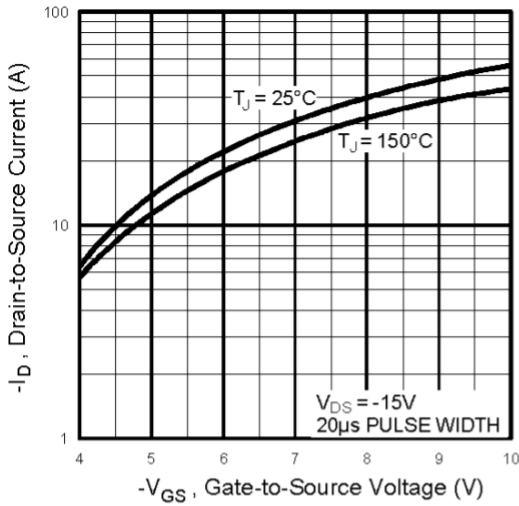


Fig 14. Typical Transfer Characteristics

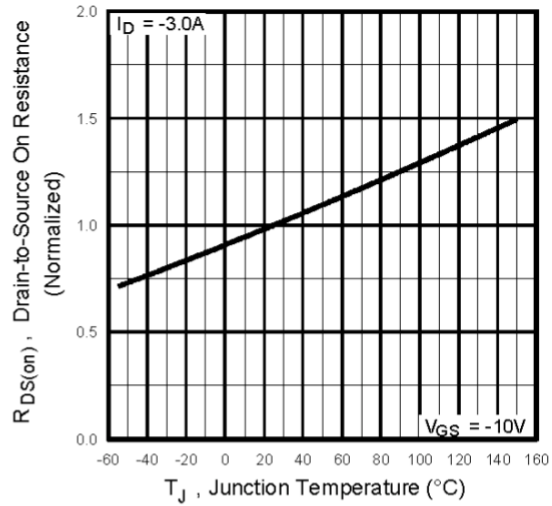


Fig 15. Normalized On-Resistance Vs. Temperature

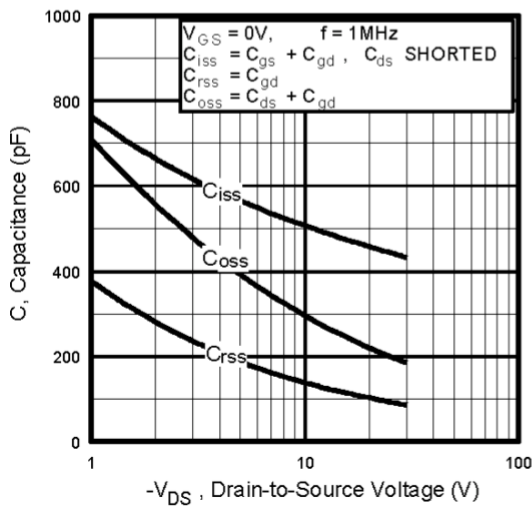


Fig 16. Typical Capacitance Vs. Drain-to-Source Voltage

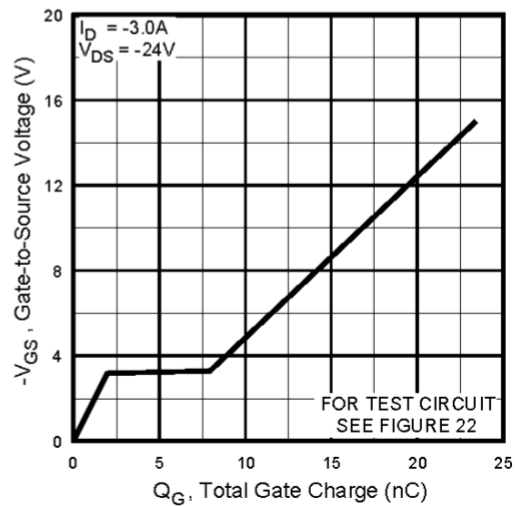


Fig 17. Typical Gate Charge Vs. Gate-to-Source Voltage

P-Channel

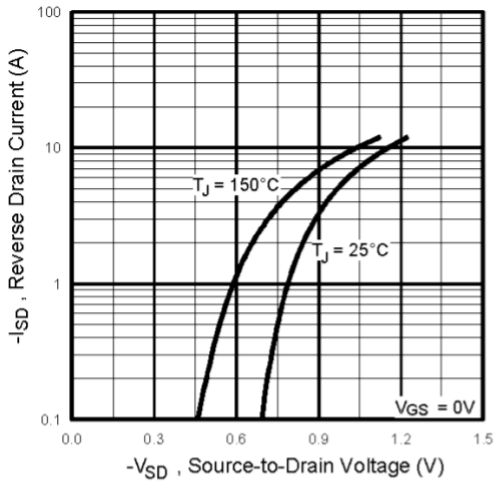


Fig 18. Typical Source-Drain Diode Forward Voltage

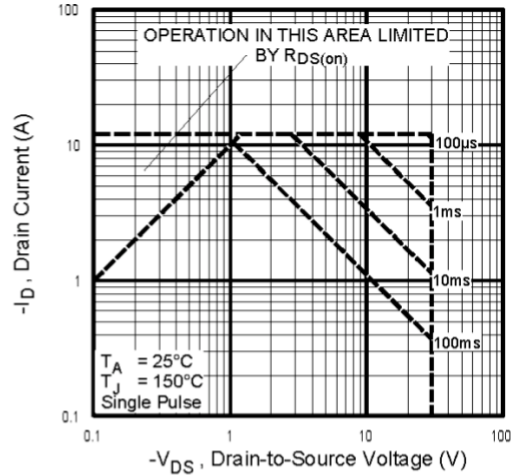


Fig 19. Maximum Safe Operating Area

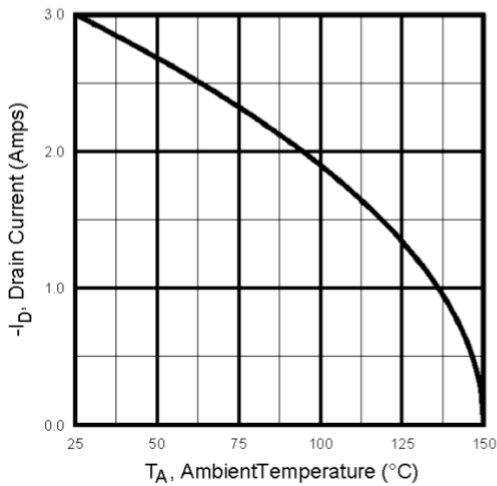


Fig 20. Max. Drain Current Vs. Ambient Temp.

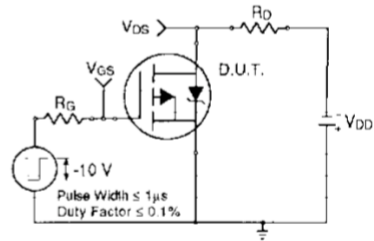


Fig 21a. Switching Time Test Circuit

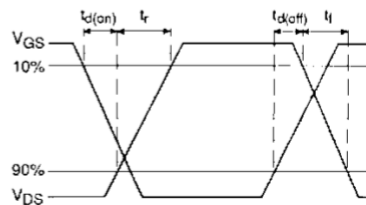


Fig 21b. Switching Time Waveforms

P-Channel

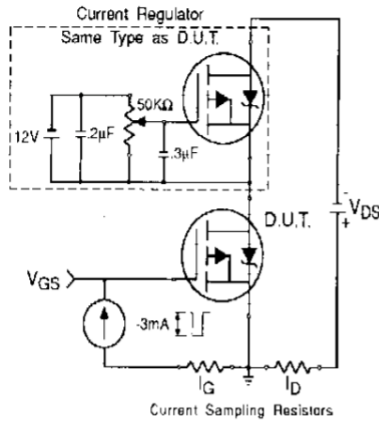


Fig 22b. Gate Charge Test Circuit

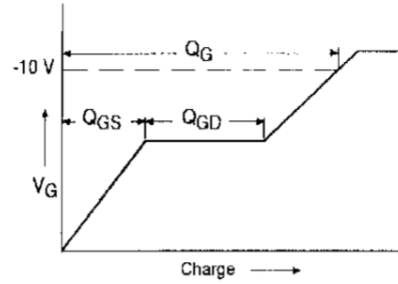


Fig 22b. Basic Gate Charge Waveform

N- and P-Channel

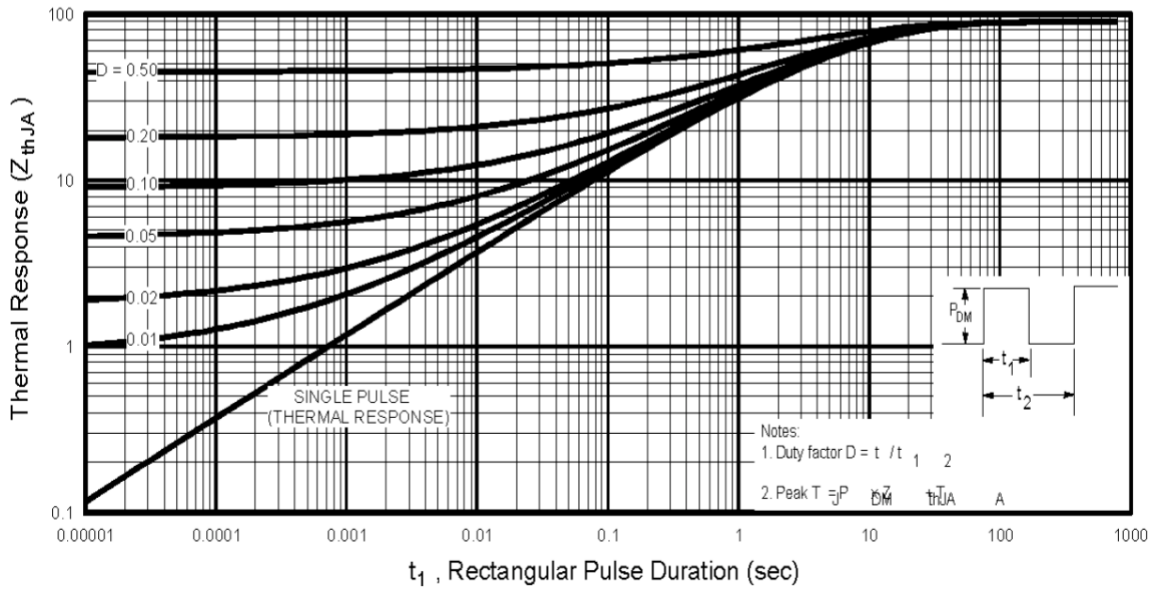
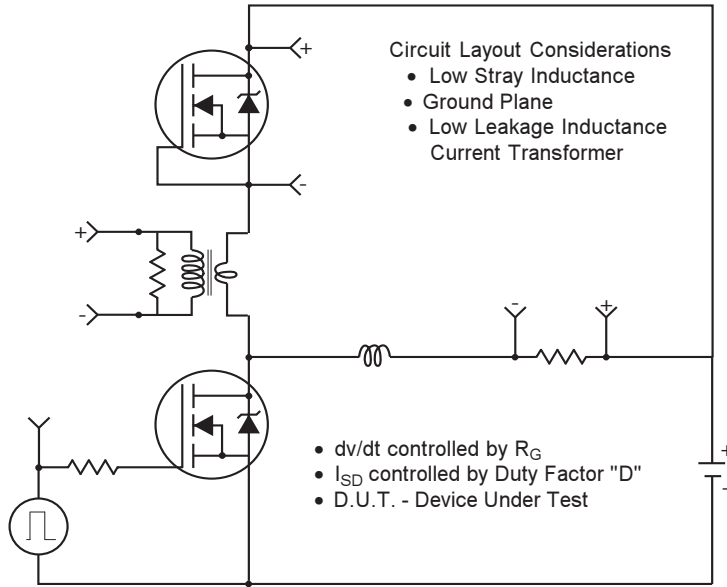


Fig 23. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

Peak Diode Recovery dv/dt Test Circuit



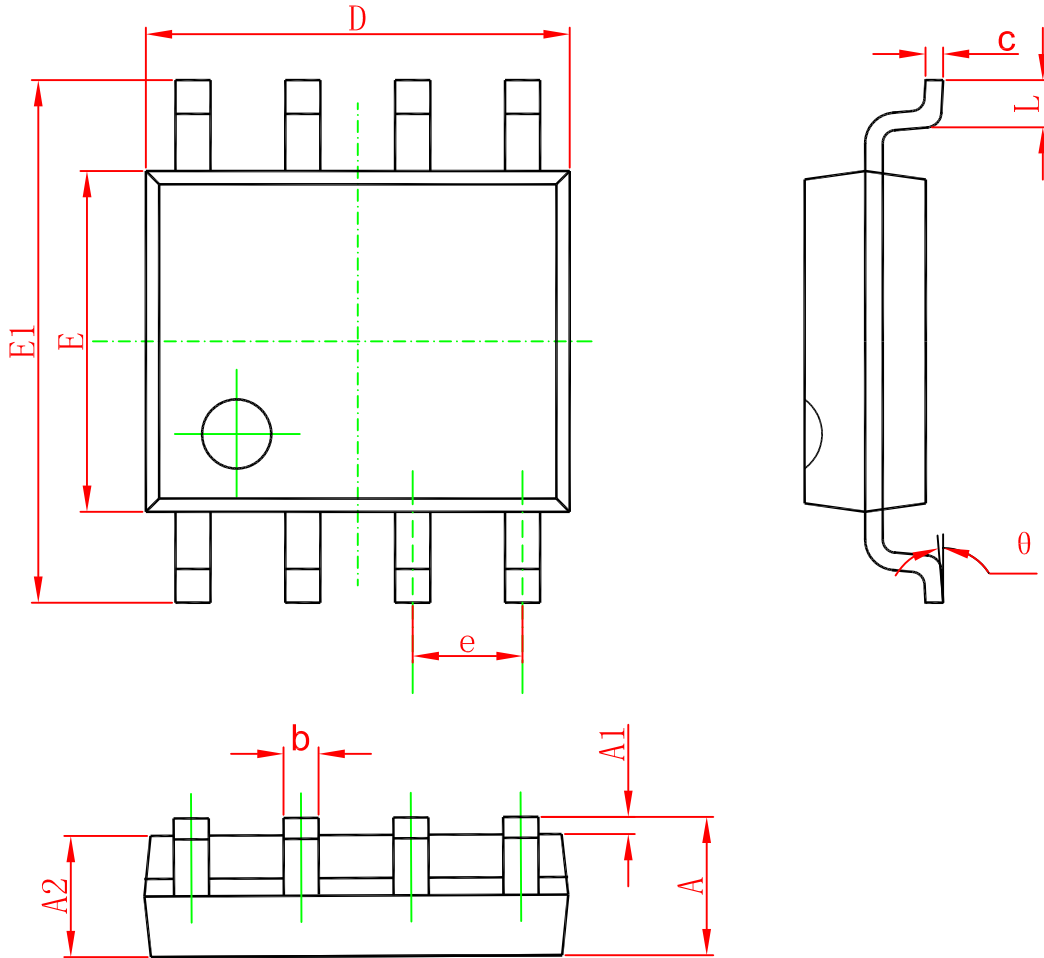
Circuit Layout Considerations

- Low Stray Inductance
- Ground Plane
- Low Leakage Inductance Current Transformer

- dv/dt controlled by R_G
- I_{SD} controlled by Duty Factor "D"
- D.U.T. - Device Under Test

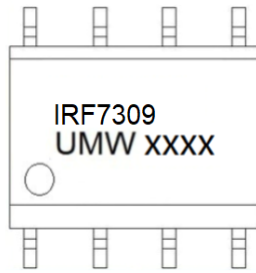
* Reverse Polarity for P-Channel
** Use P-Channel Driver for P-Channel Measurements

SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
UMW IRF7309TR	SOP-8	3000	Tape and reel

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